

TOB system test - status report

Reminder on the TOB electronics architecture

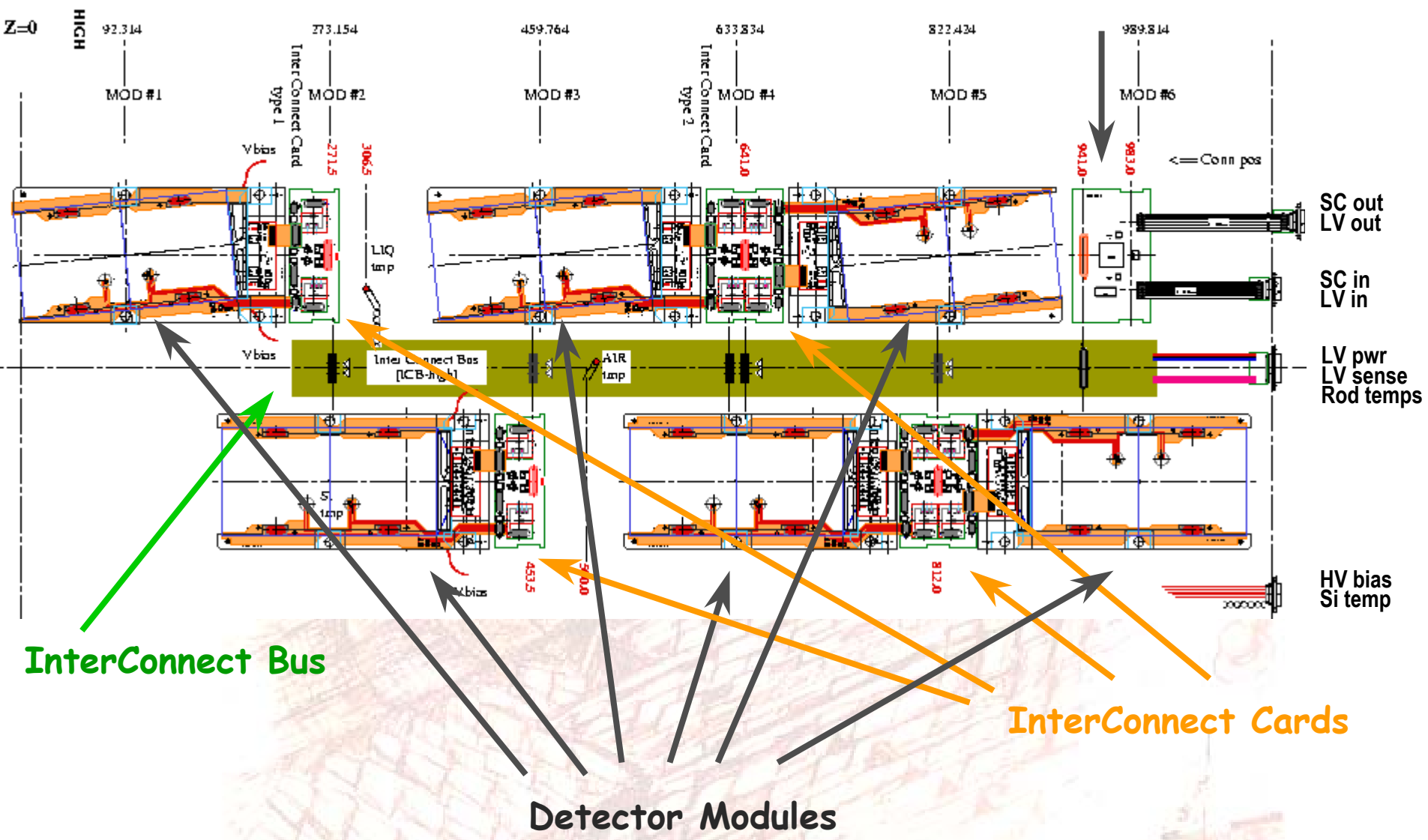
Test of the first SS rod prototype

⇒ Results

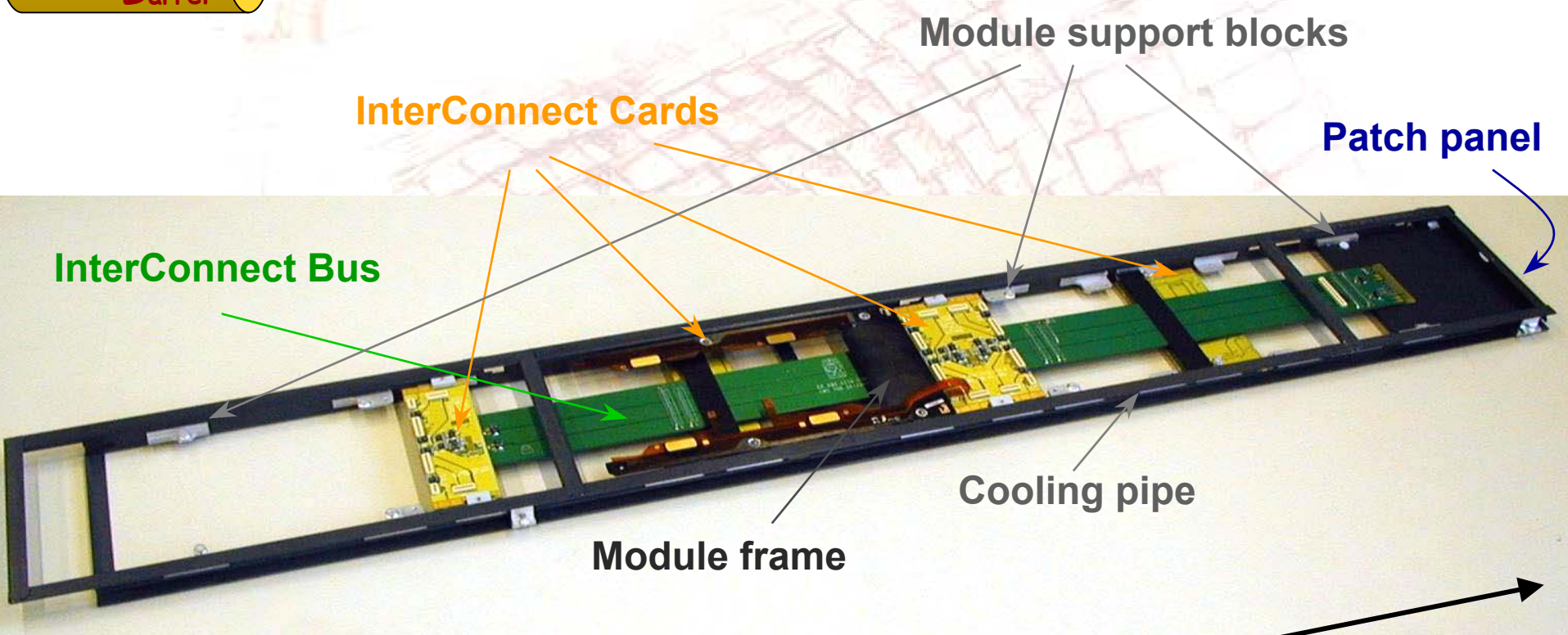
Further steps

The rod

CCU Module



The rod components



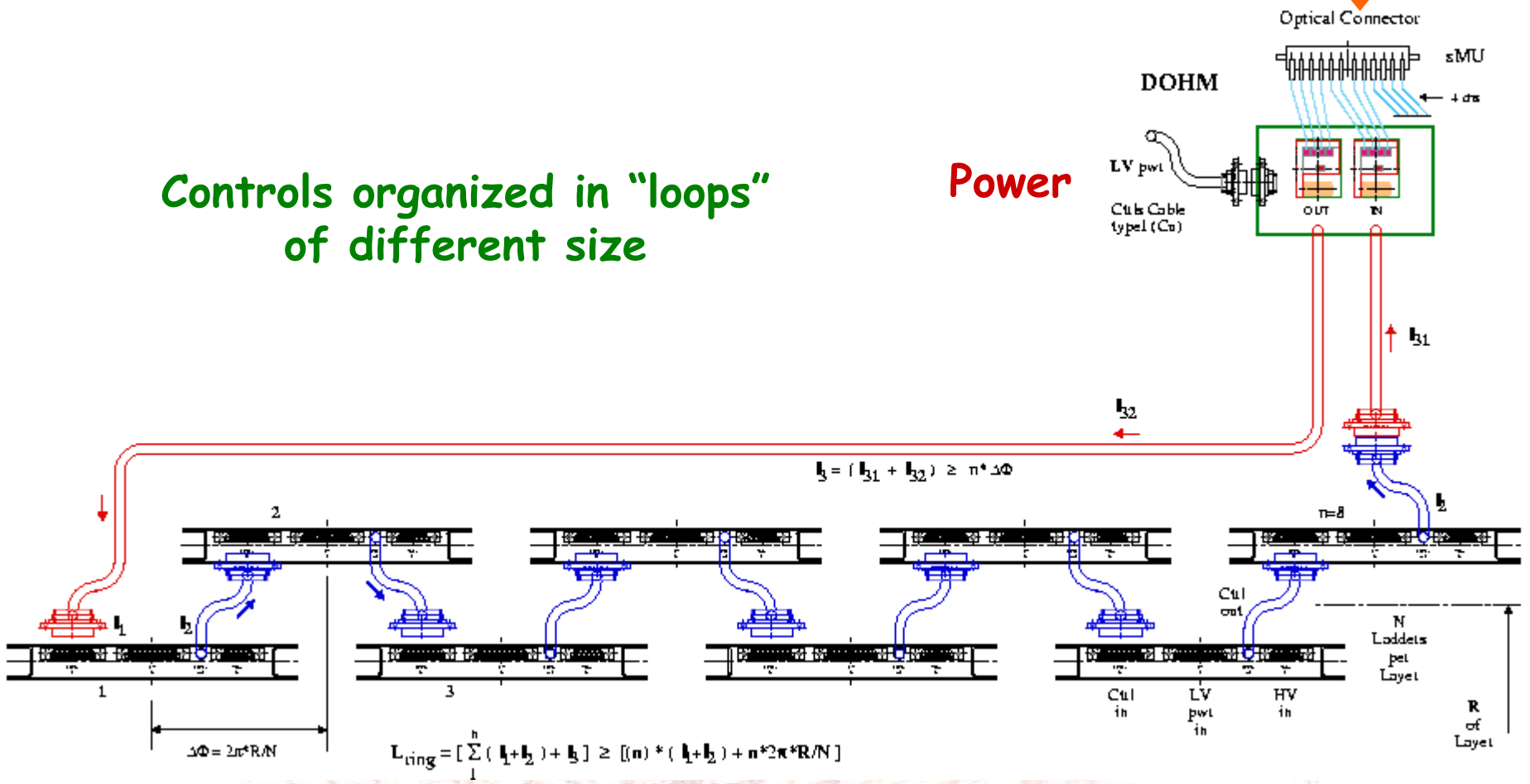
15 cm

110 cm

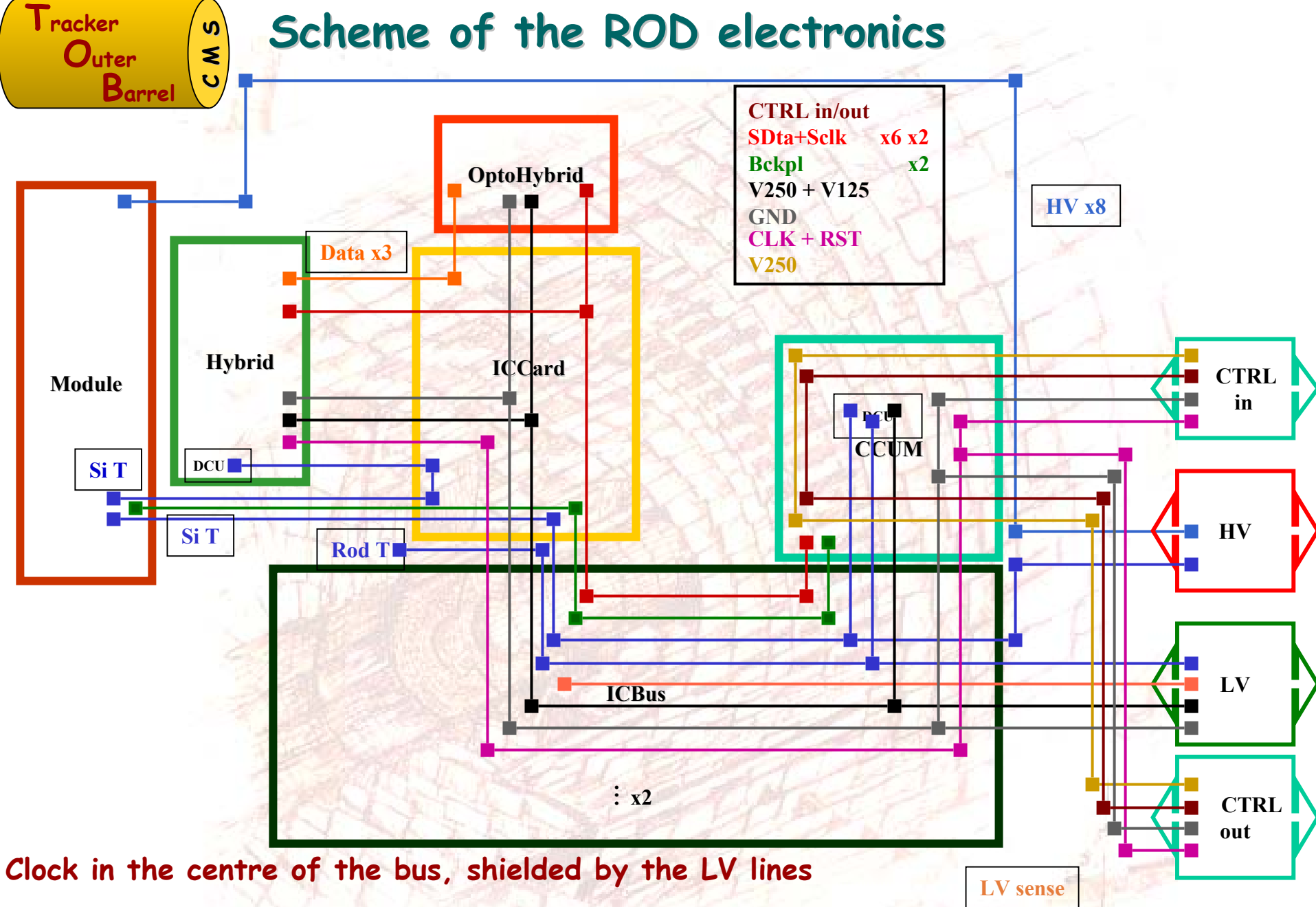
All components "final" except for the CCUM

Controls organized in "loops" of different size

Power



Scheme of the ROD electronics



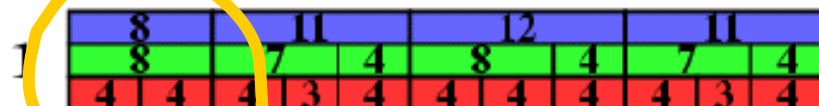
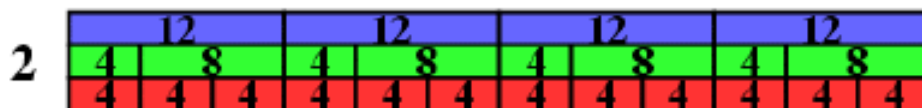
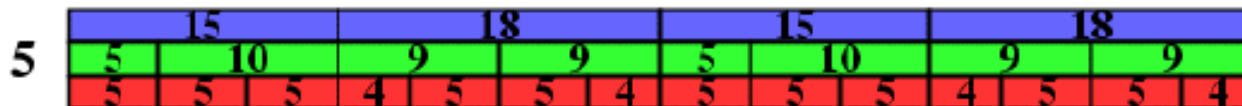
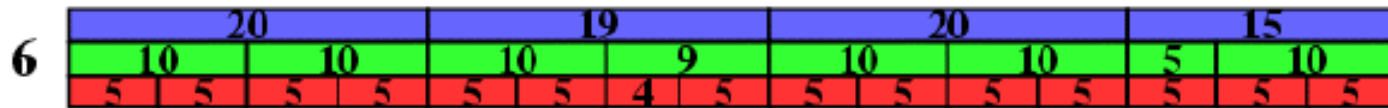
Clock in the centre of the bus, shielded by the LV lines

Cooling, control and readout grouping

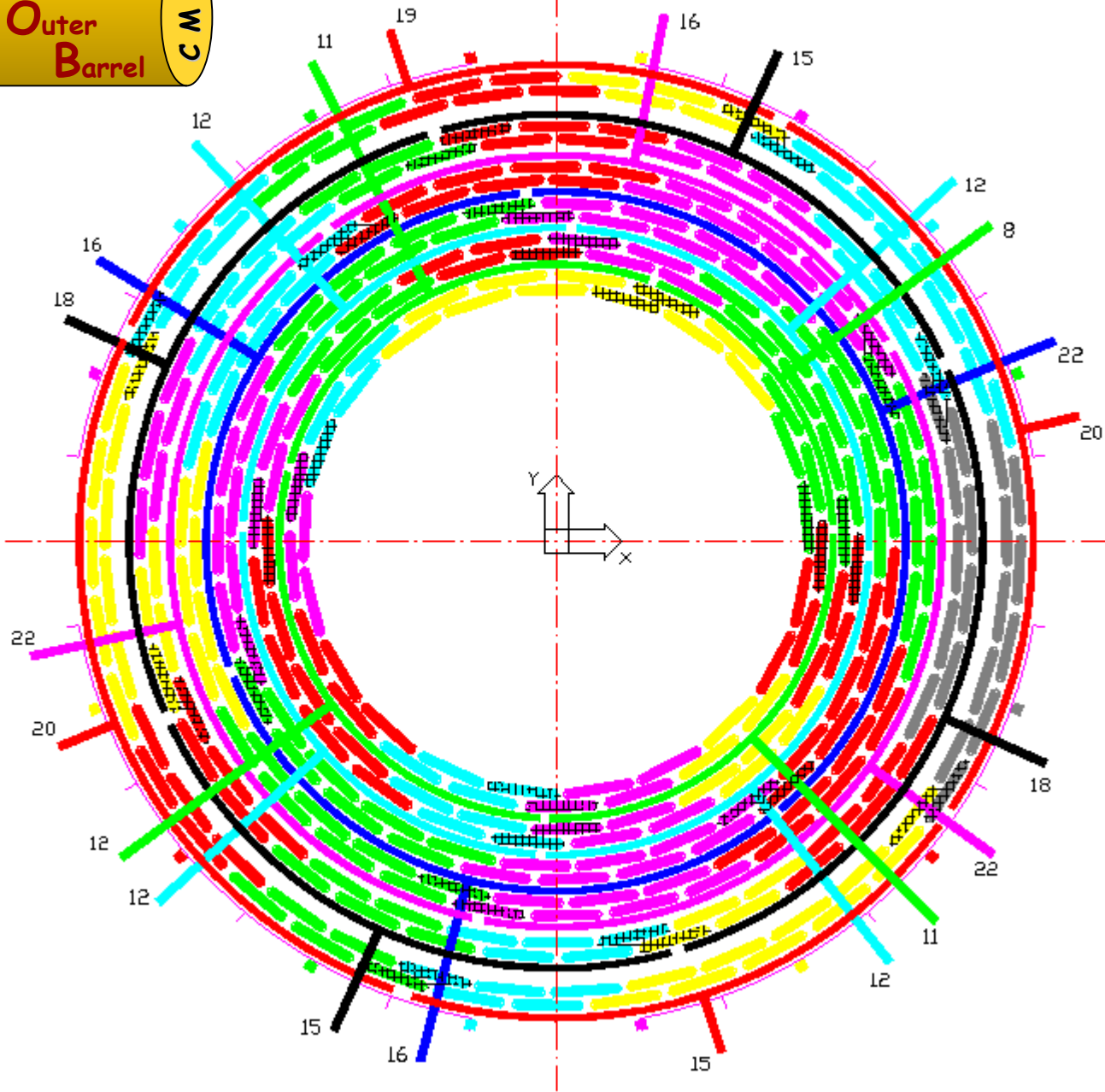
Layer

N of rods

Cooling
Control
Readout



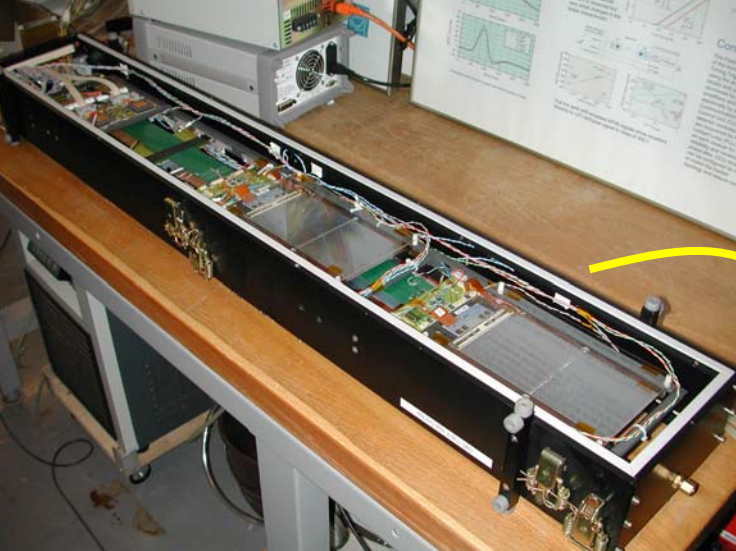
All boundaries of control loops match boundaries of cooling groups



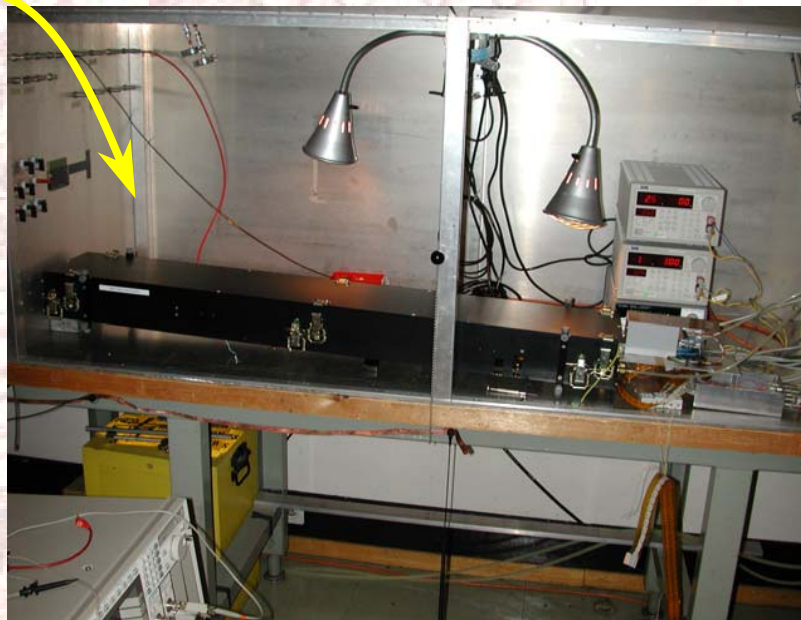
Manifolds will be used to put to ground each control loop



Electrical ground
≡
Mechanical ground



Alu box, gas tight, with patch panel for cables, fibres and pipes (cooling and dry air)
(It can house 2 rods)



C_6F_{14}
Cooling plant

External temperature and humidity probes

Modules, optohybrids*, CCUM*, high voltage

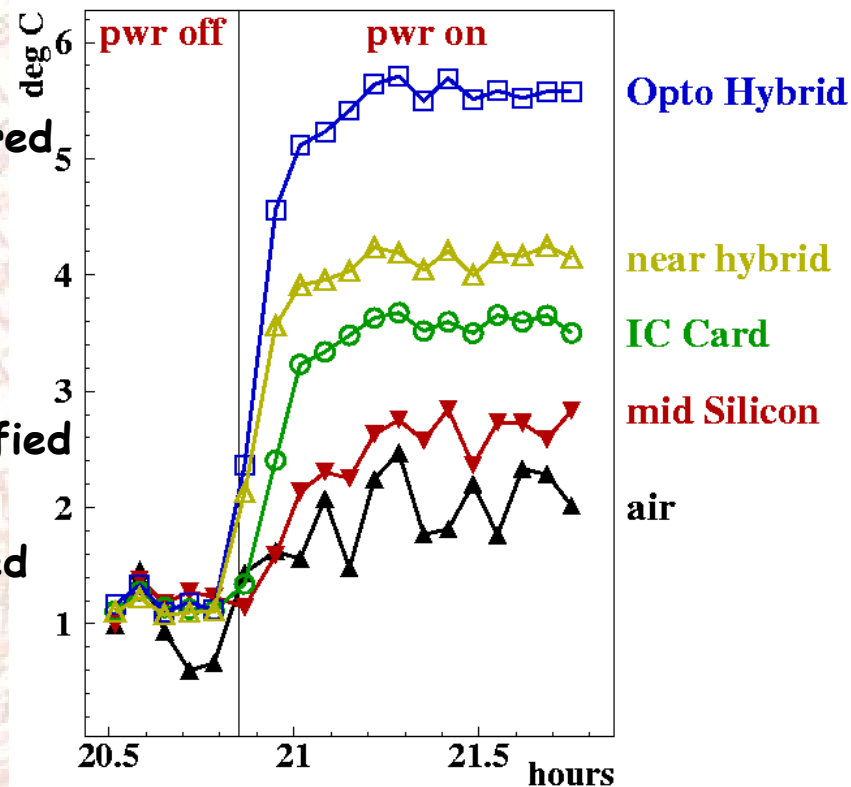
DAQ PC with 1 TSC, 1 FEC** and 3 FED cards, XDAQ Software, Monitoring.

(*) not yet the final versions

(**) electrical control link

Temperature measurements with all real components

- ✗ Temperature measurements performed with real thermal loads
(electronics in operating conditions)
- ✗ Temperature of all the rod components measured with external probes
- ✗ Internal temperature probes commissioned
- ✗ Time constants to reach stable conditions verified
- ✗ Effect of the ambient temperature investigated

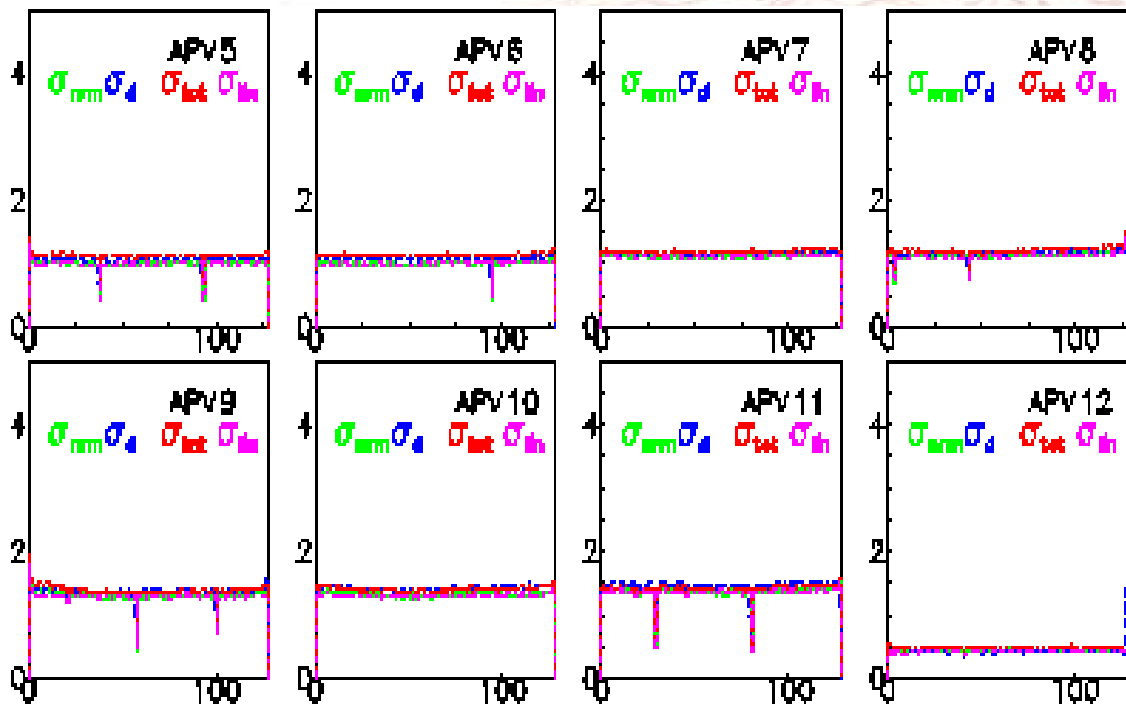


Results perfectly consistent with expectations for a SS, non-irradiated rod

Measurements summarized in a CMS Internal note

Noise profiles

Good noise profile for random triggers or low/high frequency triggers



(deconvolution)

$$\text{ped}_i = \langle \text{ADC}_i \rangle_{\text{ev}}$$

σ_{tot} : RMS of $\text{ADC}_i - \text{ped}_i$

$$\text{CMN}_0 = \langle \text{ADC}_i - \text{ped}_i \rangle_{\text{strip}}$$

σ_{nm} : RMS of $\text{ADC}_i - \text{ped}_i - \text{CMN}_0$

σ_d : RMS of $0.5(\text{ADC}_i - \text{ADC}_{i+1})$

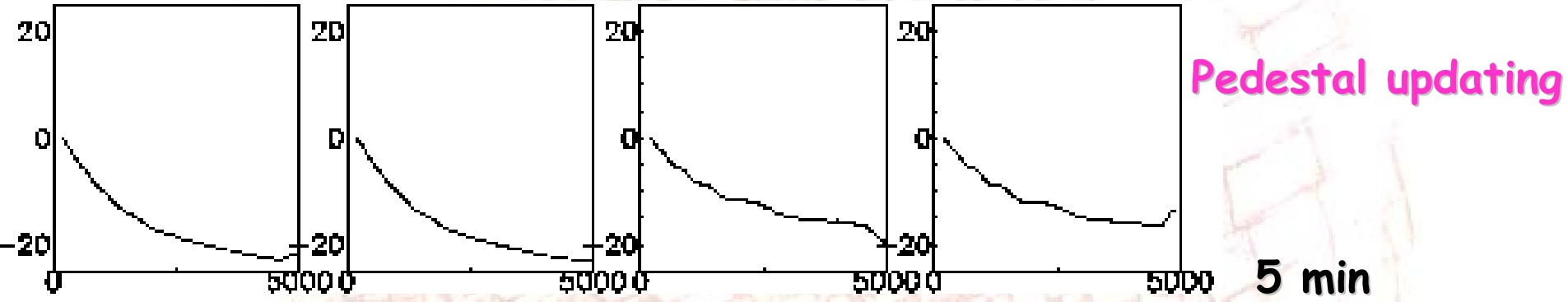
$$\text{CMN}_i = b + a i$$

σ_{lin} : RMS of $\text{ADC}_i - \text{ped}_i - \text{CMN}_i$

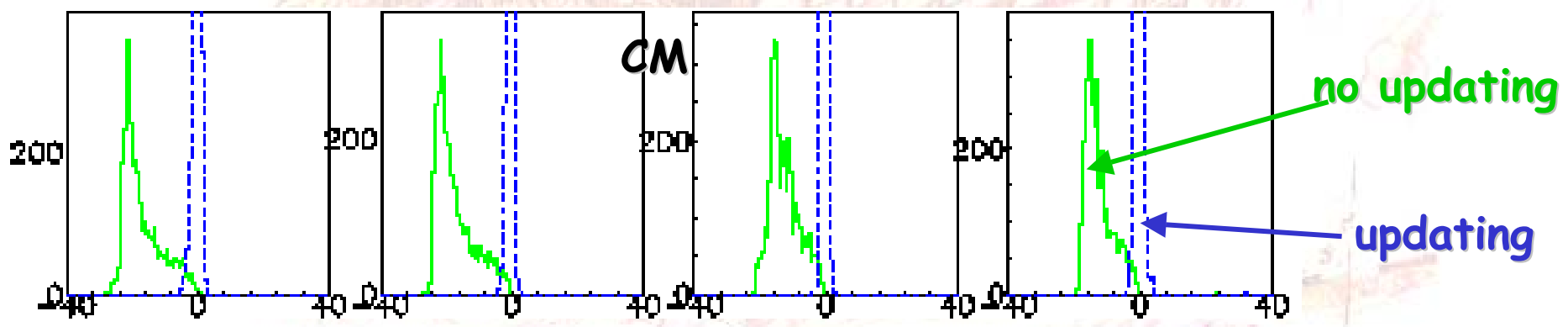
No large contribution from CMN ($\sigma_{\text{tot}} = \sigma_d$), noise is flat and gaussian (both in peak and deconvolution mode)

Pedestal drift

Drift of the pedestals in time at the beginning of a run:



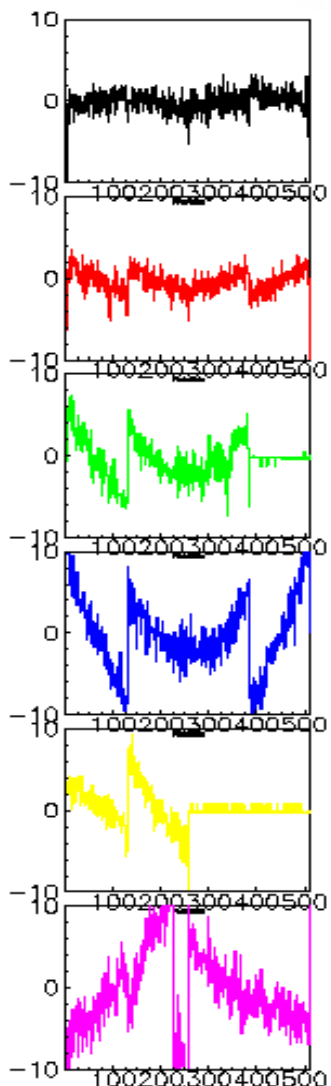
Temperature increases at the beginning due to the start of run
 ⇒ change in the threshold of the laser
 ⇒ appears as a CM shifts if pedestals are not updated



Noisy events: deconvolution @ 2KHz trigger rate

- ⇒ large non-flat CM noise
- ⇒ well described by a linear fit
- ⇒ larger effect in detectors facing the IC Bus

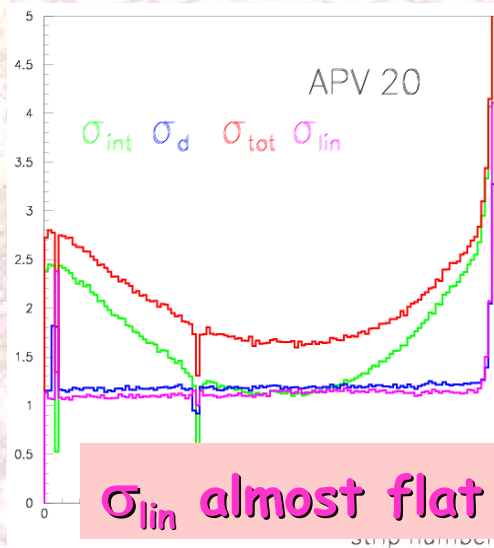
Example of bad event
(Raw-Ped is shown)



Mod. 1

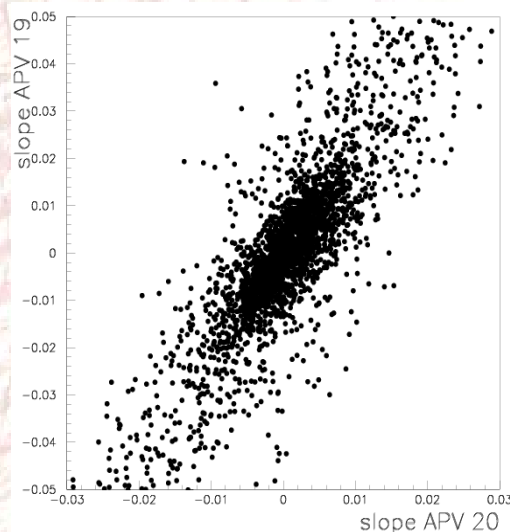
Large variation of the normal noise at the edges of the chip

IC Bus



Correlations among chips on the same module and on different modules

CM Slope fully correlated or fully anticorrelated

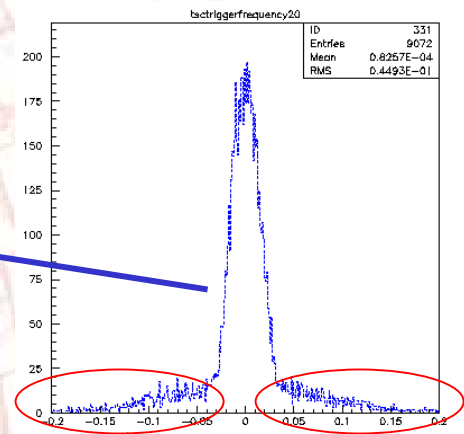
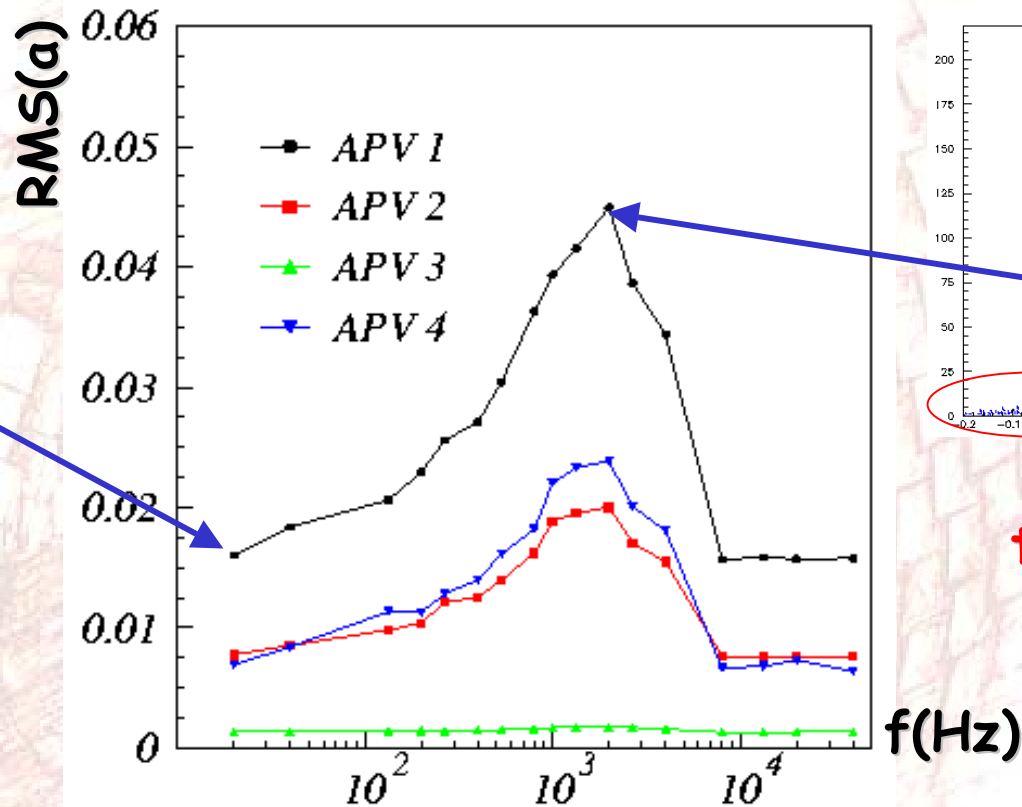
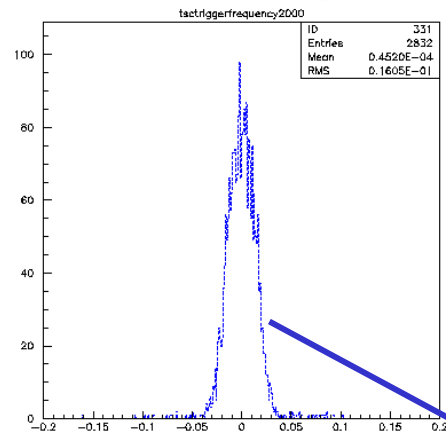


Mod. 6

RMS(CM slope) used as noise estimator in the following

Dependence of noise on trigger frequency

Dispersion of the slope vs frequency of the internal triggers



tails appear

Worst conditions at about 2KHz

Only in deconvolution mode: no striking effect in peak

The data taking scheme (XDAQ)

Tunable Number of events between two consecutive APV & FED resets

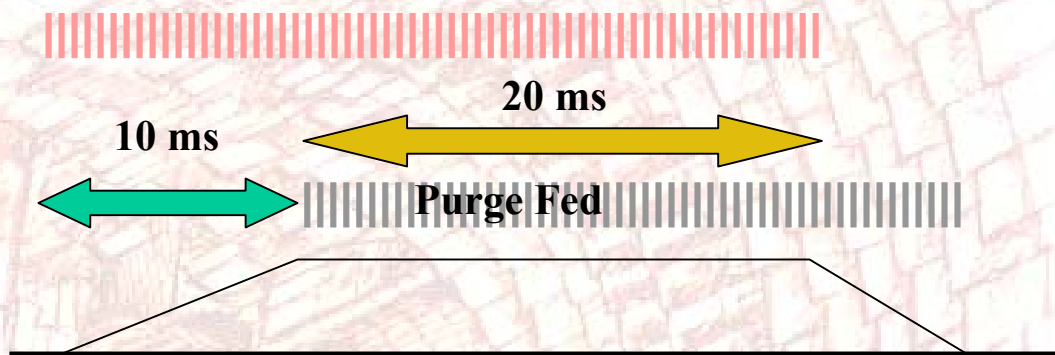
➔ Definition of Spill

❖ Example of 60 events taken at 2 KHz trigger frequency

Spill: 60 triggers

Purge Fed Delay

Fed buffer occupancy



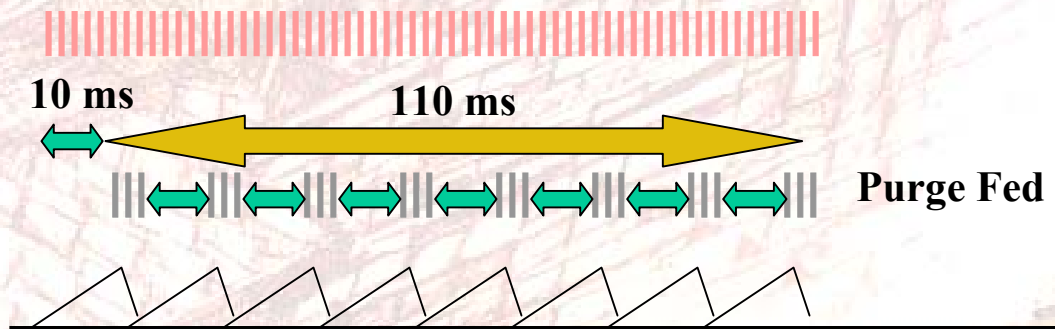
APV
&
FED
reset

❖ Example of 60 events taken at 500 Hz trigger frequency

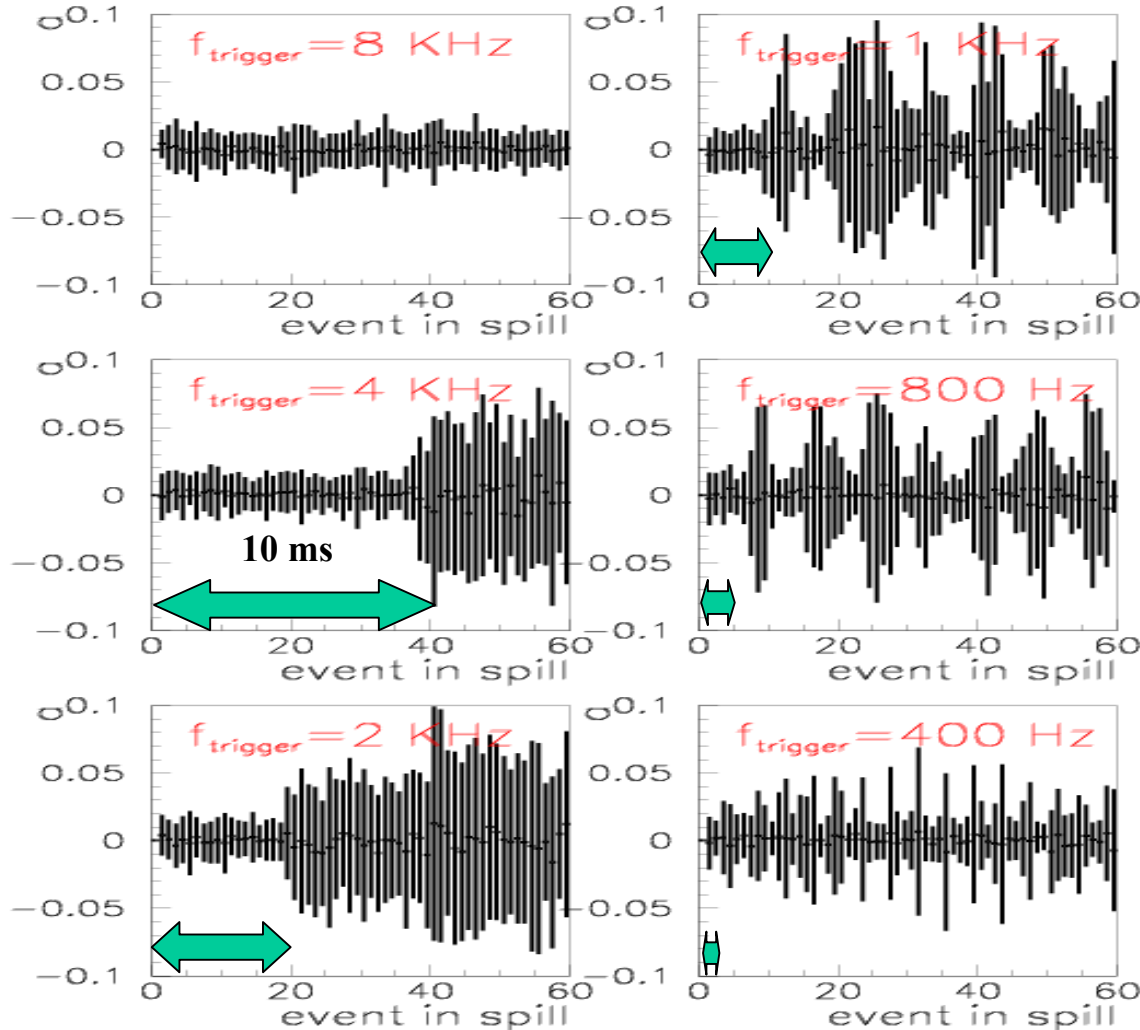
Spill: 60 triggers

Purge Fed Delay

Fed buffer occupancy



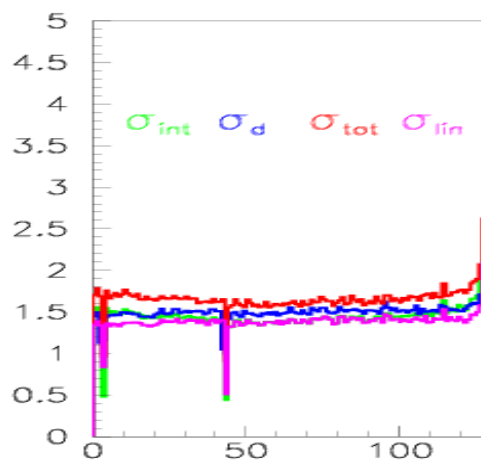
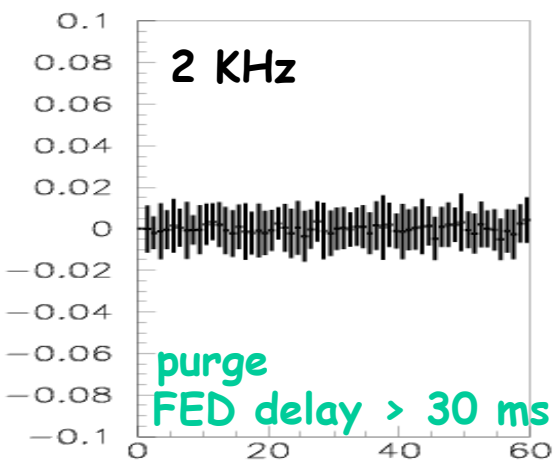
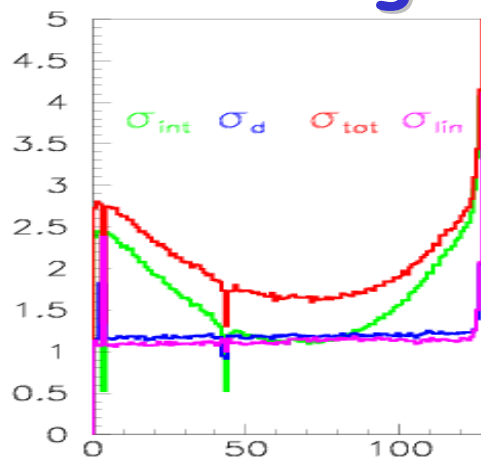
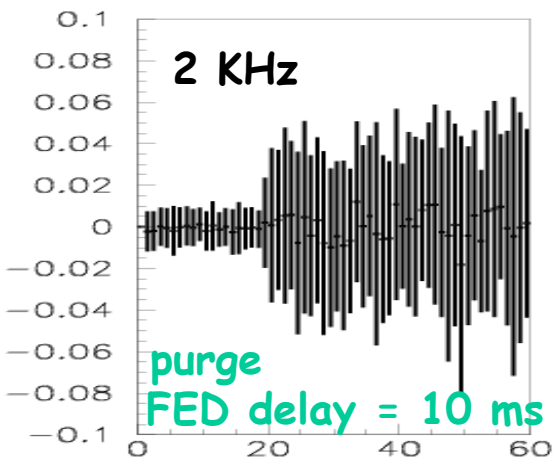
In spill analysis (frequency scan)



No large spread of CM Slope in the first 10 ms of data taking at any trigger frequency

Clear indication for a periodic variation of RMS(CM Slope)

Understanding the noise



Increase the **purge FED delay** so that the purge FED process starts after all the events in a **spill** have been collected

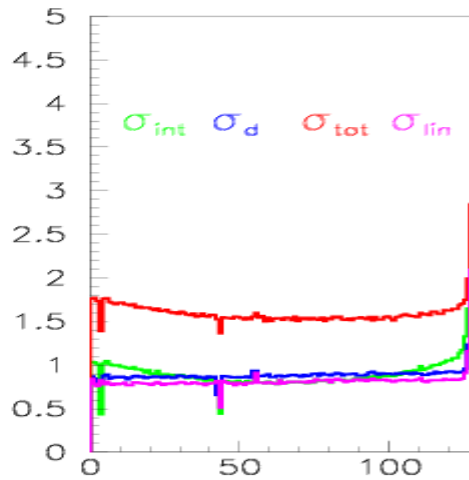
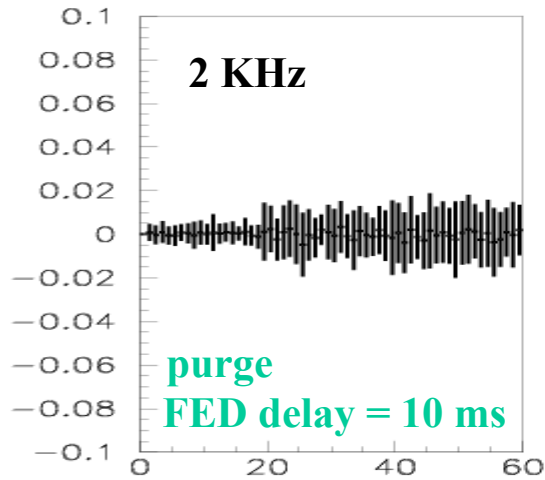


The noise arises from the purge FED process

Noise propagation: purge FED

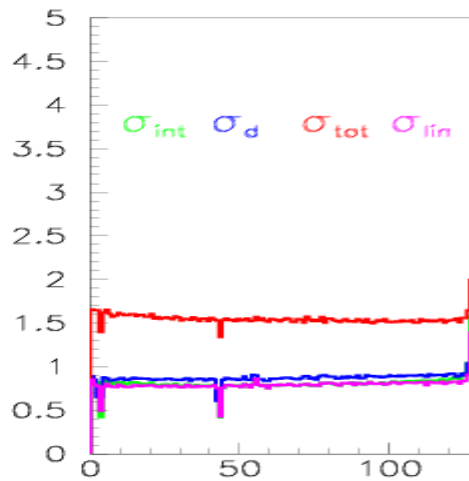
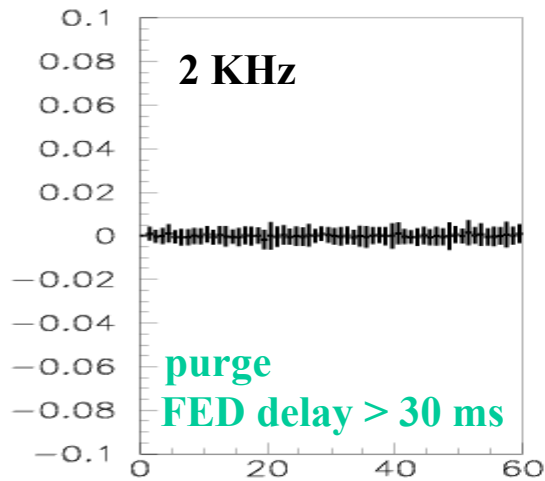
- CTRL ground line (the FEC is sitting in the same PC as the DAQ)
 - LV return line in the IC Bus
 - picked up by the modules
- Confirmed with several other tests

Is the peak mode really clean?



Small variation of the normal noise at the edges of the chip

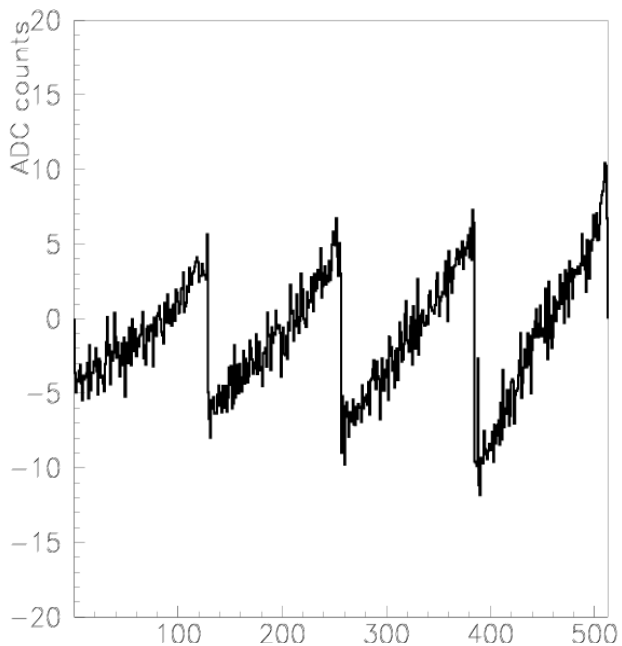
σ_{lin} flat



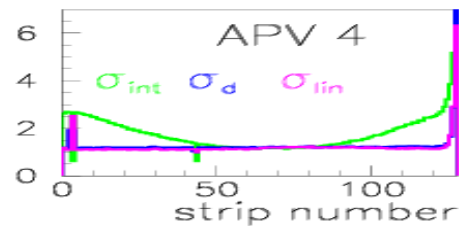
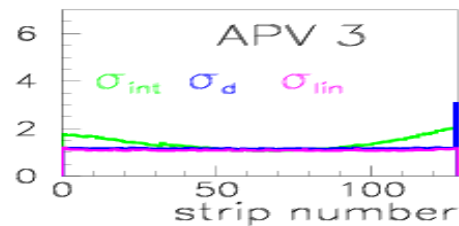
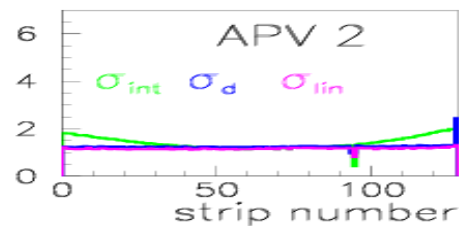
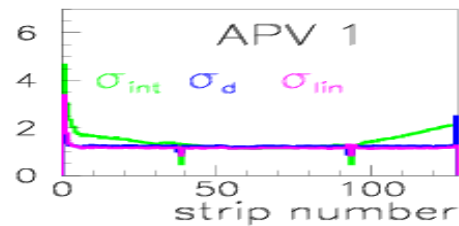
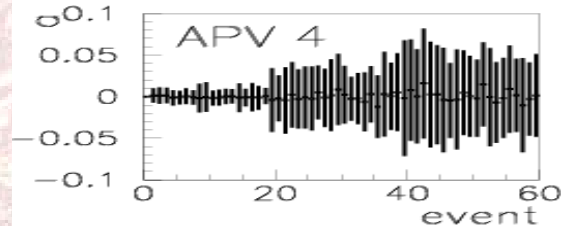
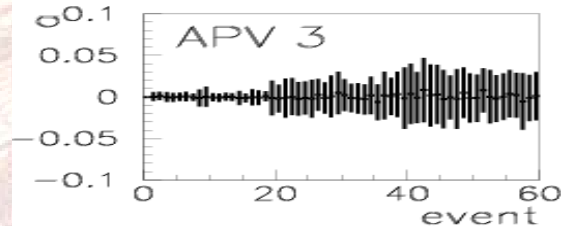
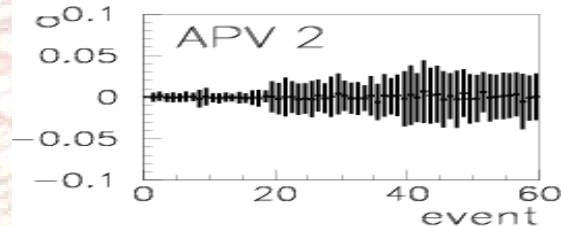
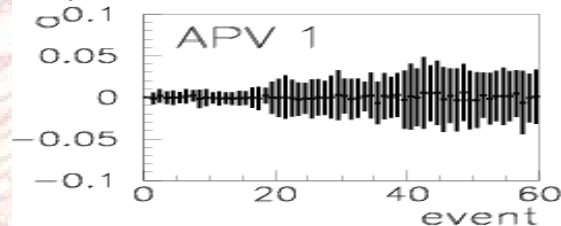
Increasing the purge FED delay the normal noise gets flat

Further tests: IC Bus alone

One module mounted on a spare Bus + CCUM + ICC + AOH
(no Cooling Pipe, no ROD frame)



Corrected raw data

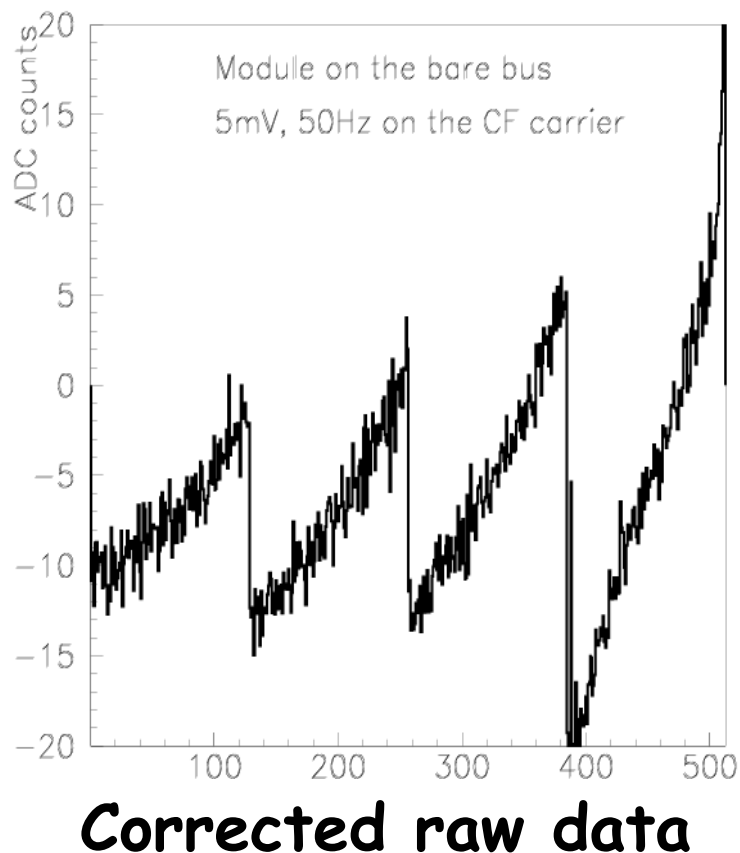


➔ CM Slope fully correlated

σ_{lin} almost flat

Injection of LF noise

❖ 5mV 50Hz (monochromatic) on module carrier



CM Slope fully correlated

(σ_{in} almost flat)

Effect more relevant for the
APV closest to the probe

Tests repeated at different trigger frequencies
Effect observed up to 5 KHz
(sensitivity at low frequencies)

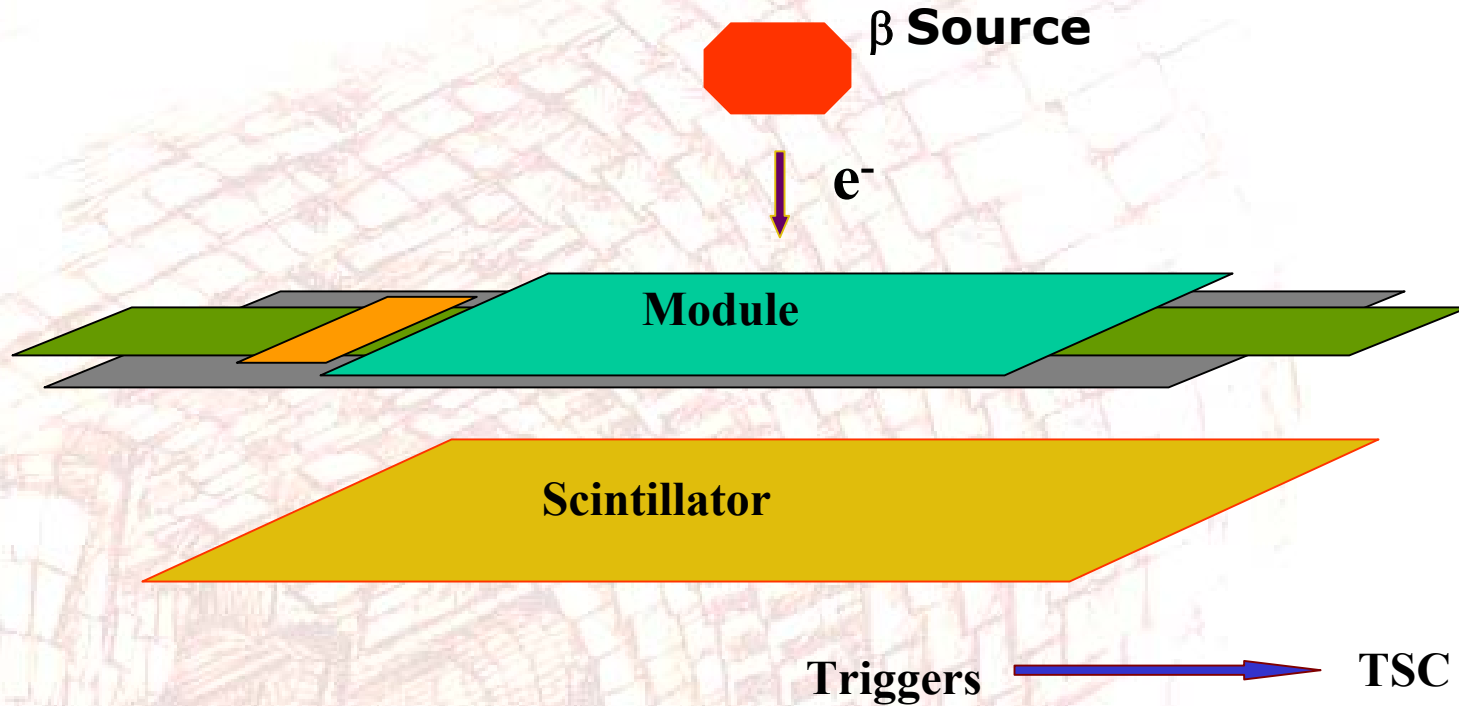
Injection of HF noise

❖ 4V on antenna 1 cm from module

- Linear CM induced also in this case
- Sensitivity at high frequencies
 - From frequencies as low as 500 KHz
- Evidence of local effects
 - Highest sensitivity close to pitch adapter and bonds

Special module with pitch adapter mounted on a kapton foil:
effect not confirmed

Measurements of physics signals



Peak

Deconvolution

inverted mode

inverted mode

$S/N \approx 21$

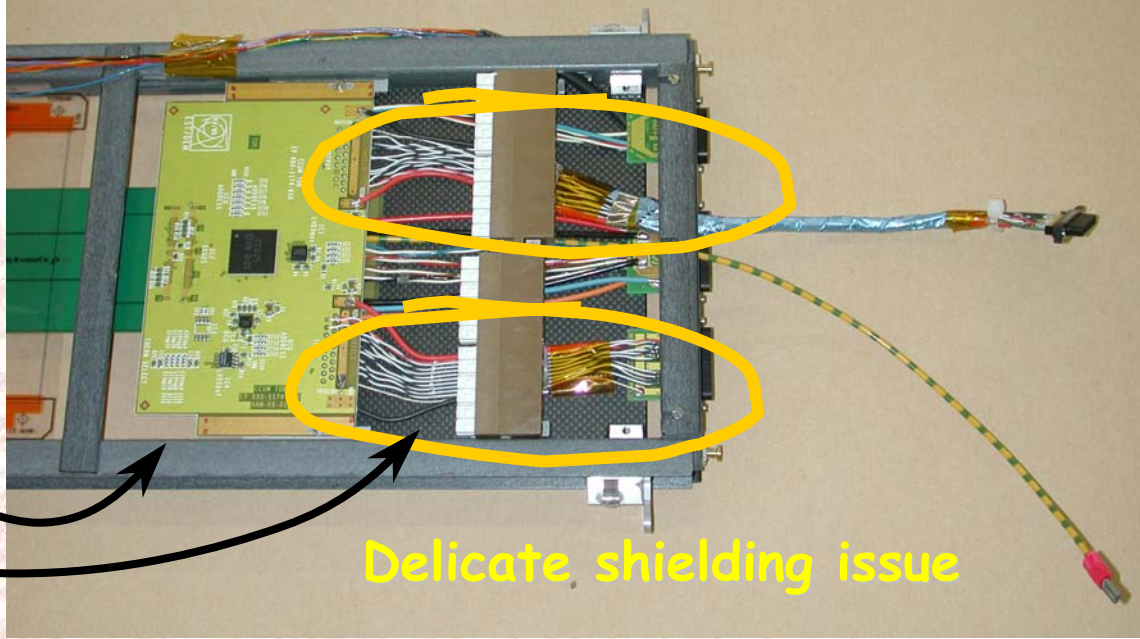
$S/N \approx 15$

Conclusions

- A SS rod prototype has been tested thoroughly
- No problem has been identified in the electrical design
- The grounding seems to be valid
- Clock signals are well shielded in the IC Bus
- Modules are sensitive to noise on the LV lines
(hint that the sensitivity comes from the pitch adapter was not confirmed)
- The system reacts to noise sources with a non flat correlated noise
- Such correlated noise is (typically) perfectly described by a linear fit

The robustness of the system would be greatly increased by a calculation of the common mode with a nonzero slope

Outlook



A DS rod prototype is now being integrated

- Final CCUM
- Final cabling
- Final optohybrids

Delicate shielding issue

Will be tested with optical control (finish by Xmas?)

Further steps:

- Integrate a SS rod with final components and test two rods together
- Test a rod @ operating temperature